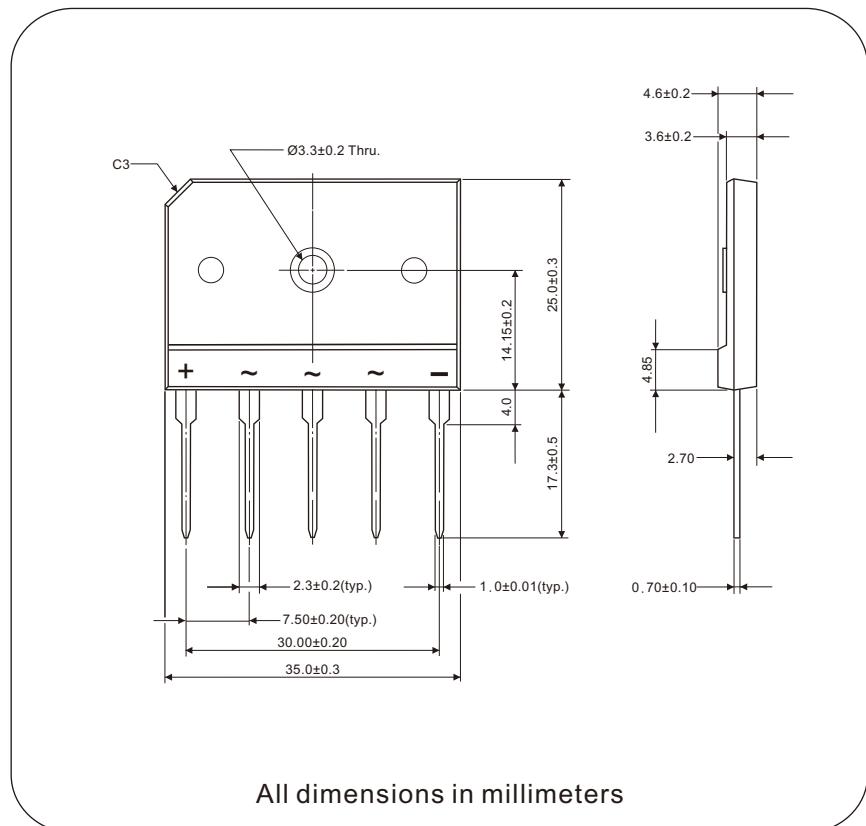
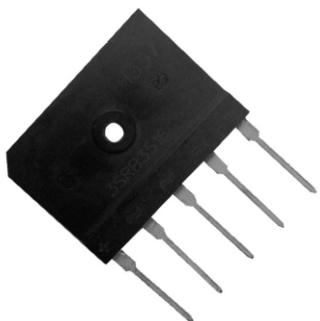


Glass Passivated Three-Phase Bridge Rectifier, 50A

MTP5008L Thru MTP5016L



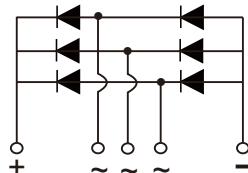
FEATURES

- UL recognition file number E320098
- Typical IR less than 2.0 μA
- High surge current capability
- Low thermal resistance
- Compliant to RoHS
- Isolation voltage up to 2500V



TYPICAL APPLICATIONS

General purpose use in AC/DC bridge full wave rectification for big power supply, field supply for DC motor, industrial automation applications.



ADVANTAGE

- International standard package
Epoxy meets UL 94 V-O flammability rating
- Small volume, light weight
- Small thermal resistance
- High heat-conduction rate
- Low temperature rise
- High temperature soldering guaranteed :
260°C/10 second, 2.3kg tension force
- Weight: 11g (0.39 ozs)

PRIMARY CHARACTERISTICS

$I_{F(AV)}$	50A
V_{RRM}	800V to 1600V
I_{FSM}	500A
I_R	10 μA
V_F	1.10V
$T_{J \max.}$	150°C

MAJOR RATINGS AND CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted)					
PARAMETER	SYMBOL	MTP50..L			UNIT
		08	12	16	
Maximum repetitive peak reverse voltage	V_{RRM}	800	1200	1600	V
Peak reverse non-repetitive voltage	V_{RSM}	900	1300	1700	V
Maximum DC blocking voltage	V_{DC}	800	1200	1600	V
Maximum average forward rectified output current, $T_C = 80^\circ\text{C}$	$I_{F(AV)}$	50		A	
Peak forward surge current single sine-wave superimposed on rated load	I_{FSM}	500		A	
Rating (non-repetitive, for t greater than 1 ms and less than 10 ms) for fusing	I^2t	1250		A^2s	
RMS isolation voltage from case to leads	V_{ISO}	2500		V	
Operating junction storage temperature range	T_J	-55 to 150		$^\circ\text{C}$	
Storage temperature range	T_{STG}	-55 to 150		$^\circ\text{C}$	

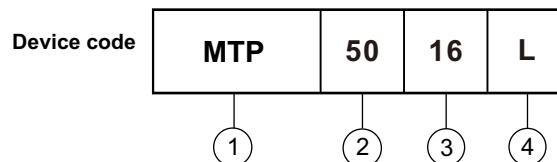
ELECTRICAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ unless otherwise noted)							
PARAMETER	TEST CONDITIONS	SYMBOL	MTP50..L			UNIT	
			08	12	16		
Maximum instantaneous forward drop per diode	$I_F = 25\text{A}$	V_F	1.10		V		
Maximum reverse DC current at rated DC blocking voltage per diod	$T_A = 25^\circ\text{C}$	I_R	10		μA		
	$T_A = 150^\circ\text{C}$		1000				

THERMAL AND MECHANICAL ($T_A = 25^\circ\text{C}$ unless otherwise noted)							
PARAMETER	TEST CONDITIONS	SYMBOL	MTP50..L			UNIT	
			08	12	16		
Typical thermal resistance junction to case	Single-side heat dissipation, sine half wave	$R_{th(j-c)}^{(1)}$	0.96		$^\circ\text{C/W}$		
Mounting torque to heatsink M3 $\pm 10\%$	A mounting compound is recommended and the torque should be rechecked after a period of 3 hours to allow for the spread of the compound.		0.8		$\text{N}\cdot\text{m}$		
Approximate weight			11		g		

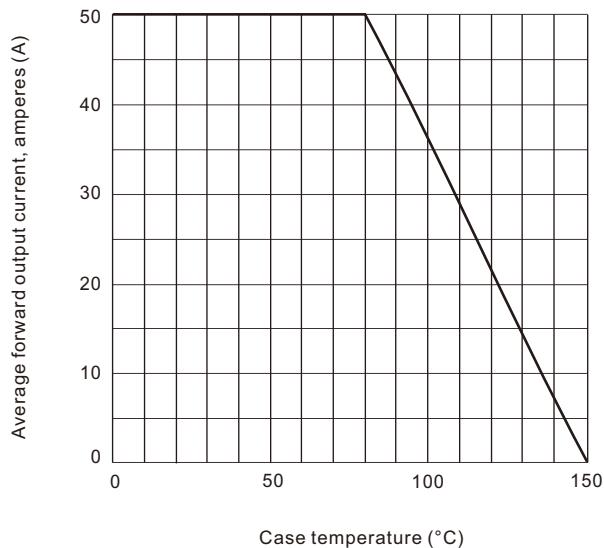
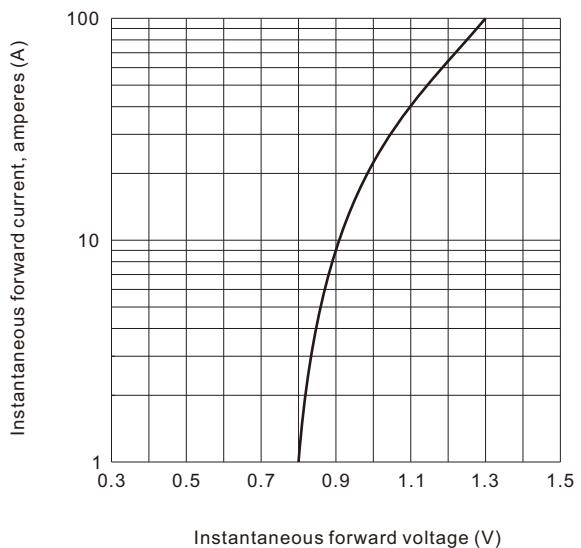
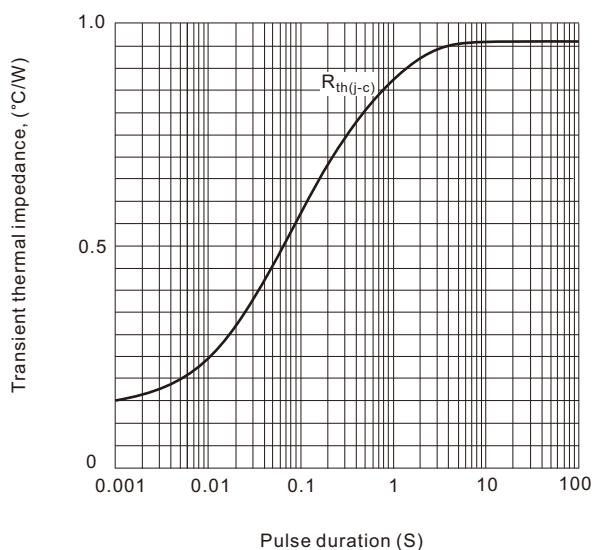
Notes

(1) With heatsink, single side heat dissipation, half sine wave.

Ordering Information Tabel



- [1] - Product type : "MTP" Package,3Ø Bridge (Three-phase bridge)
- [2] - $I_{F(AV)}$ rating : "50" for 50A
- [3] - Voltage code : code x 100 = V_{RRM}
- [4] - L: SIP (Single-in-line) package

Fig.1 Forward current derating curve

Fig.2 Forward characteristics

Fig.3 Transient thermal impedance

Fig.4 Max Non-repetitive forward surge current
